

Customer No.: 31561
Application No.: 10/064,424
Docket No.: 9407-US-PA

REMARKS

Applicant would like to elect Group I, claims 1-9, drawn to a laminate substrate structure, classified in class 174, subclass 262. Please cancel the following three Groups without wavier, prejudice or disclaimer:

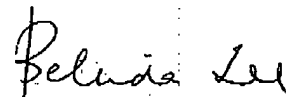
1. Group II, claims 10-17, drawn to a process of making a laminate substrate structure, classified in class 29, subclass 830;
2. Group III, claims 18-26, drawn to a process of making a laminate substrate structure, classified in class 29, subclass 830;
3. Group IV, claim 27, drawn to a process of making a laminate substrate structure, classified in class 29, subclass 846.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Respectfully submitted,

Date :

Oct. 1, 2004



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